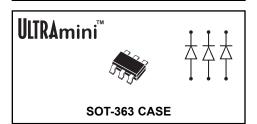
CMKD4448

SURFACE MOUNT
ULTRAmini™
TRIPLE ISOLATED
HIGH SPEED
SILICON SWITCHING DIODES



Central Semiconductor Corp.

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMKD4448 type contains three (3) Isolated High Speed Silicon Switching Diodes, manufactured by the epitaxial planar process, epoxy molded in an ULTRAmini™ surface mount package, designed for applications requiring high speed switching applications.

MARKING CODE: K48

MAXIMUM RATINGS: $(T_A=25^{\circ}C)$

	SYMBOL		UNITS
Continuous Reverse Voltage	V_{R}	75	V
Peak Repetitive Reverse Voltage	V_{RRM}	100	V
Continuous Forward Current	I _F	250	mA
Peak Repetitive Forward Current	I _{FRM}	250	mA
Forward Surge Current, tp=1 µsec.	I _{FSM}	4000	mA
Forward Surge Current, tp=1 sec.	I _{FSM}	1000	mA
Power Dissipation	P_{D}	250	mW
Operating and Storage			
Junction Temperature	T_J , T_{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	500	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (T_A=25°C unless otherwise noted)

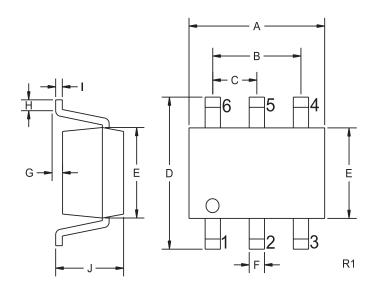
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_R	V _R =20V		25	nA
BV_R	I _R =5.0μA	75		V
BV_R	I _R =100μA	100		V
V_{F}	I _F =100mA		1.0	V
C_T	V _R =0, f=1 MHz		4.0	pF
t _{rr}	$I_R = I_F = 10$ mA, $R_L = 100\Omega$ Rec. to 1.0mA		4.0	ns

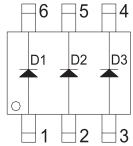


CMKD4448

SURFACE MOUNT ULTRAmini™ TRIPLE ISOLATED HIGH SPEED SILICON SWITCHING DIODES

SOT-363 CASE - MECHANICAL OUTLINE





LEAD	CO	DE:
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- 1) ANODE 1 2) ANODE 2
- 3) ANODE 3
- 4) CATHODE 3
- 5) CATHODE 2
- 6) CATHODE 1

DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.073	0.085	1.85	2.15		
В	0.051		1.30			
С	0.026		0.65			
D	0.075	0.091	1.90	2.30		
Е	0.043	0.055	1.10	1.40		
F	0.006	0.012	0.15	0.30		
G	0.000	0.004	0.00	0.10		
Н	0.010	-	0.25	-		
	0.004	0.010	0.10	0.25		
J	0.031	0.039	0.80	1.00		

SOT-363 (REV: R1)

MARKING CODE: K48

R1 (13-November 2002)